



PATENT

Atty. Docket No. 8055-83 CIP (In1292USD1)

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

APPLICANT(S): **Gerald Friese**

Examiner: **William A. Powell**

SERIAL NO.: **09/893,160**

Group Art Unit: **1765**

FILED: **June 27, 2001**

FOR: **POWER PADS FOR APPLICATION OF HIGH CURRENT  
PER BOND PAD IN SILICON TECHNOLOGY**

Dated: **June 10, 2003**

Mail Stop Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**TRANSMITTAL OF FORMAL DRAWINGS**

Sir:

Applicant submits herewith six (6) sheets of formal drawings  
depicting FIGS. 1-7 for this application.

Respectfully submitted,

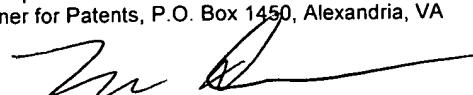
  
\_\_\_\_\_  
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**CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postpaid in an envelope addressed to the: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on June 10, 2003.

Dated: June 10, 2003

  
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**Frank V. DeRosa**

03-03



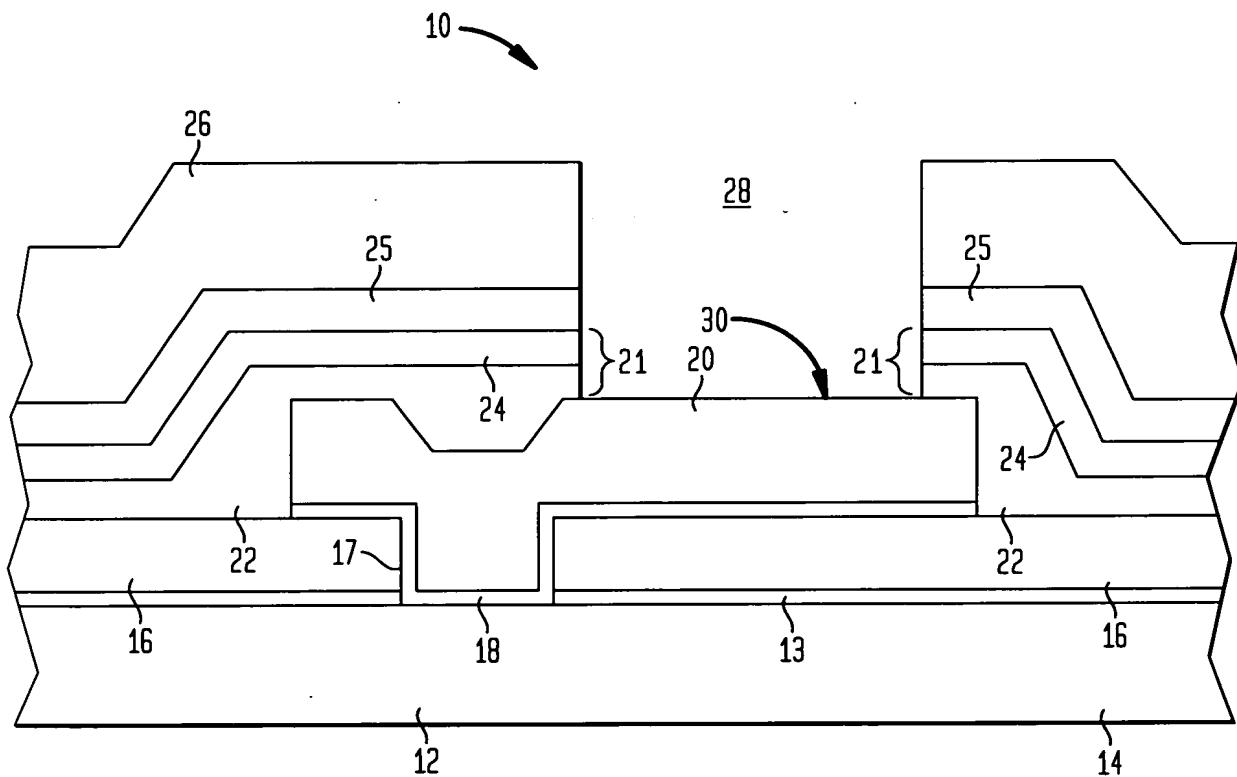
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FIG. 1

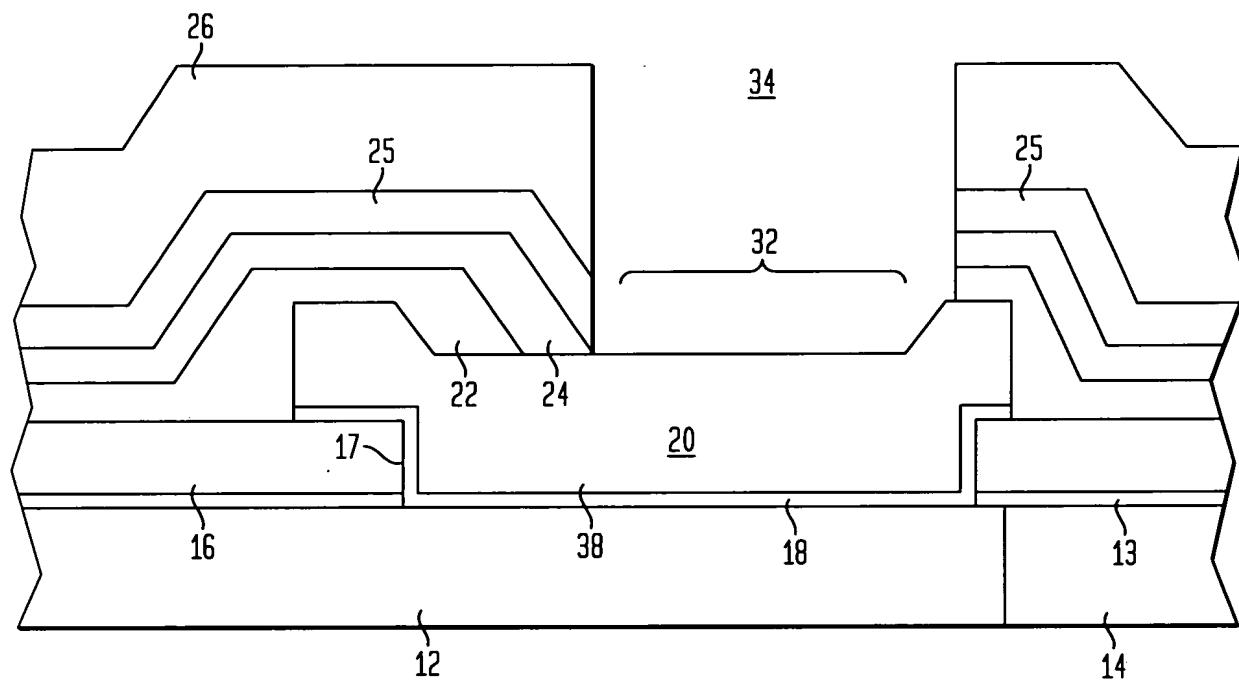




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FIG. 2

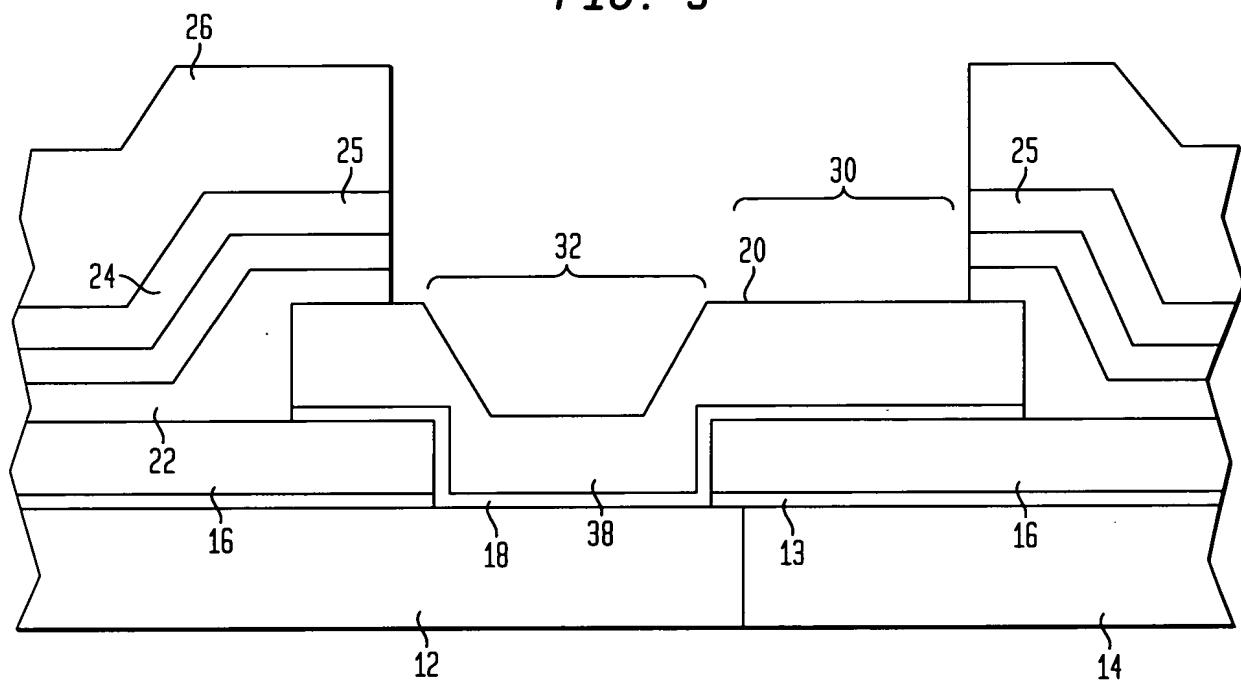




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FIG. 3



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FIG. 4

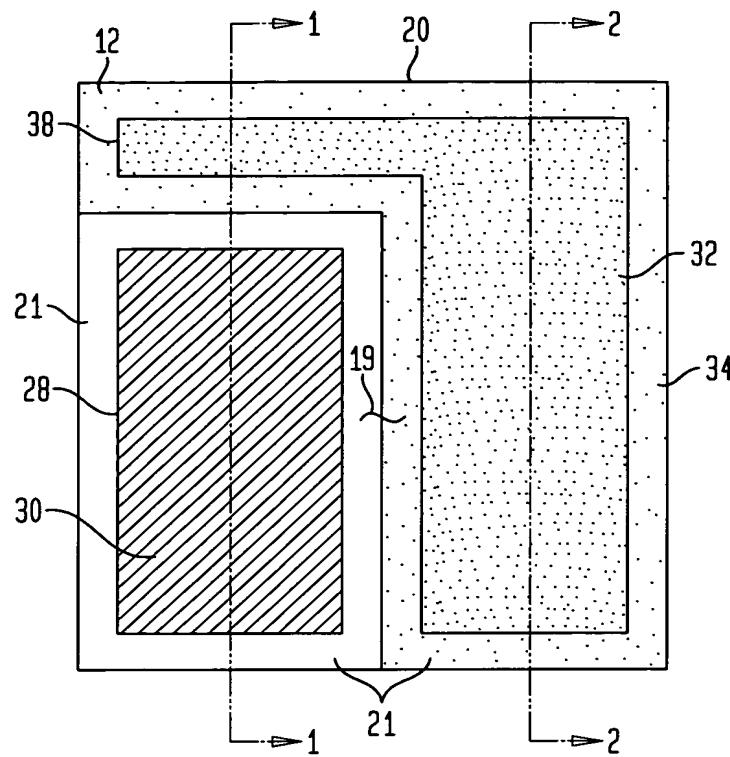
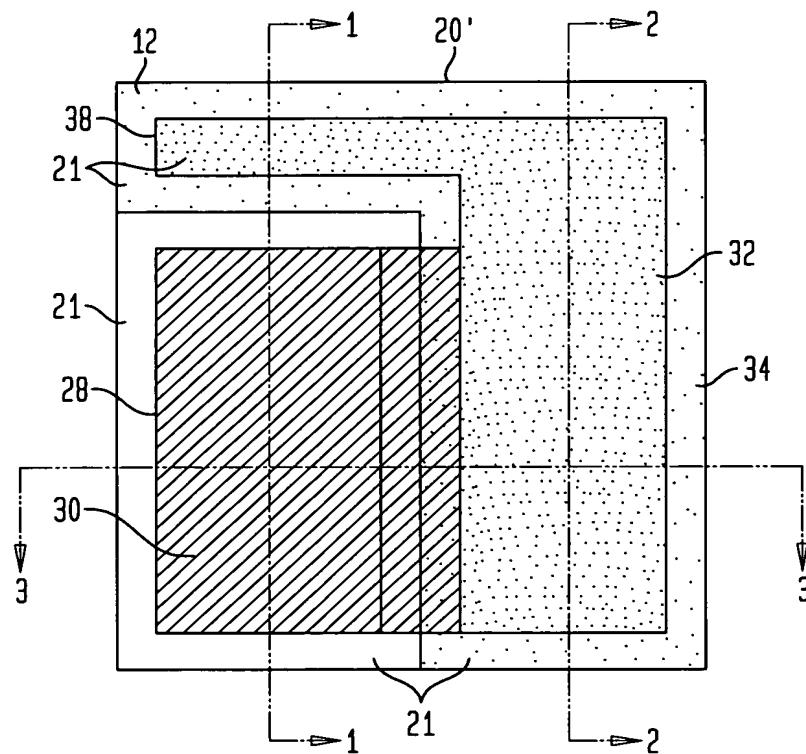


FIG. 5

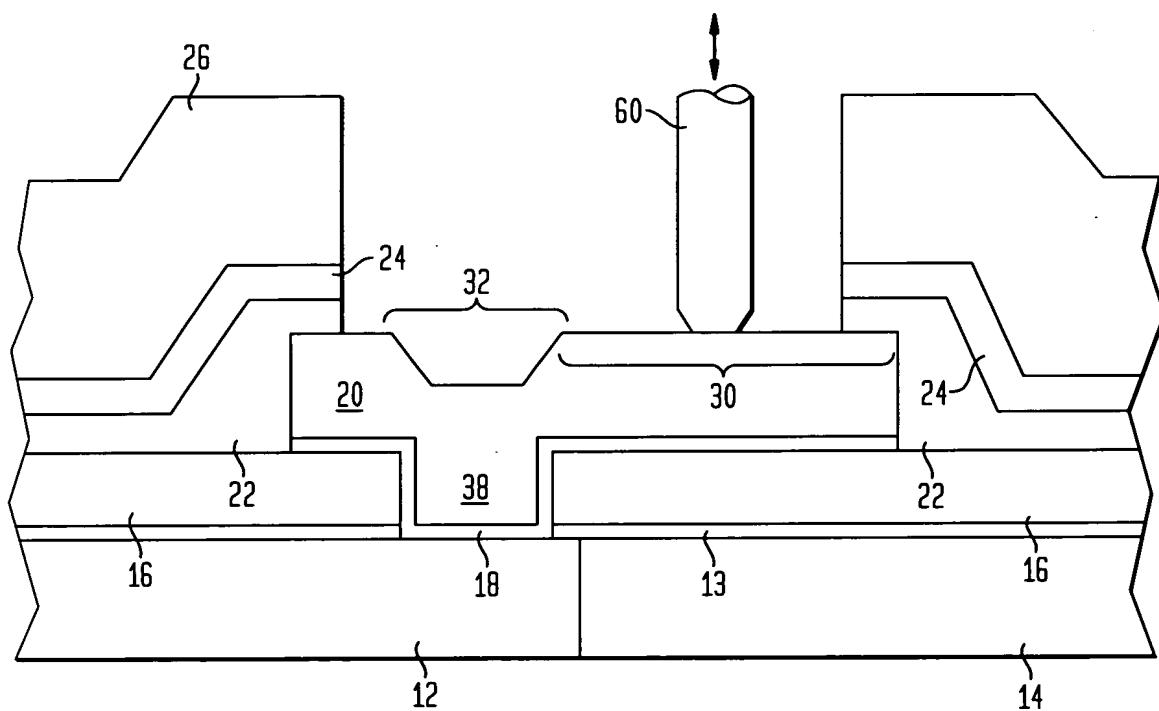




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*FIG. 6*





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FIG. 7

